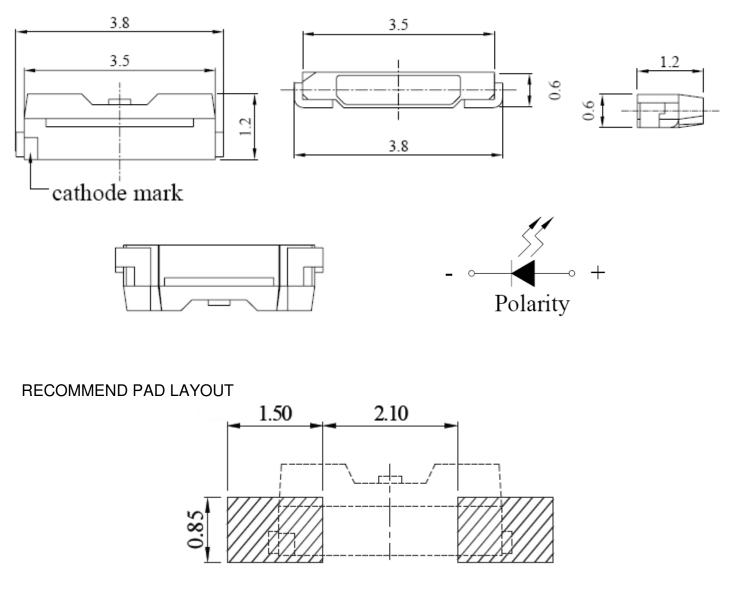


3.8 x 1.2 x 0.6 Green SMD, Tape and Reel

PACKAGE OUTLINES



NOTES:

1. All dimensions are in millimeters tolerance is ± 0.1 mm unless otherwise noted;

Part Number	Material	Lens Color	
		Emitted	Lens
L234NPGC-TR	InGaN	Green	Water Clear



3.8 x 1.2 x 0.6 Green SMD, Tape and Reel

ABSOLUTE MAXIMUM RATINGS (Ta=25					
Parameter	Symbol	Ratings	Unit		
Reverse Voltage	Vr	5	V		
Forward Current	lf	30	mA		
Peak Forward Current (Duty 1/10@10ms)	lfp	100	mA		
Power Dissipation	Pd	120	mW		
Electrostatic Discharge	ESD	500	V		
Operating temperature range	Topr	-20~+80	°C		
Storage temperature range	Tstg	-30~+100	°C		
Soldering temperature range	Tsol	Reflow soldering: 260°C for 10 sec. Hand soldering: 350°C for 3 sec.			

OPTICAL-ELECTRICAL CHARACTERISTICS

(Ta=25°C)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Luminous Intensity	lv		320		1250	mcd
Dominant Wavelength	λD		519		531	nm
Spectral Radiation Bandwidth	Δλ	I _F =20mA		30		nm
Forward Voltage	Vf		2.8		4.0	V
Viewing Angle	2⊖ ½			120		Deg
Reverse Current	lr	V _R =5V			50	μA

Note: 1. Tolerance of luminous intensity: ±15%

2. Tolerance of dominant wavelength: ±1nm

3. Tolerance of forward voltage: ±0.05V



3.8 x 1.2 x 0.6 Green SMD, Tape and Reel

BIN RANGE OF LUMINOUS INTENSITY

Bin	Min	Мах	Unit	Condition
Т	320	500	- mcd	I _F =20mA
U	500	800		
V-1	800	1000		
V-2	1000	1250		

BIN RANGE OF DOMINANT WAVELENGTH

Bin Code	Min	Мах	Unit	Condition
10	519	522	- nm	I _F =20mA
1P	522	525		
1Q	525	528		
R	528	531		

BIN RANGE OF FORWARD VOLTAGE

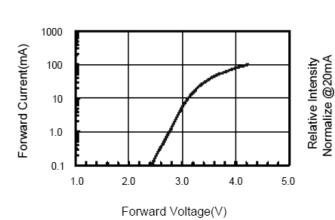
Bin Code	Min	Мах	Unit	Condition
1	2.8	3.0		I _F =20mA
2	3.0	3.2		
3	3.2	3.4		
4	3.4	3.6		
5	3.6	3.8		
6	3.8	4.0		



3.8 x 1.2 x 0.6 Green SMD, Tape and Reel

TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES

Fig.1 Forward current vs. Forward Voltage



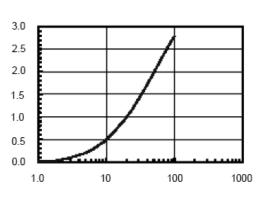


Fig.2 Relative Intensity vs. Forward Current

Forward Current(mA)

Fig.3 Forward Voltage vs. Temperature

Fig.4 Relative Intensity vs. Temperature

3.0

2.5

2.0

1.5 1.0

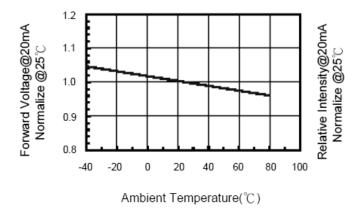
0.5

0.0

-40

-20

0





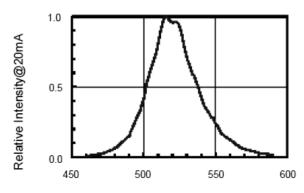


Fig.6 Directive Radiation

20

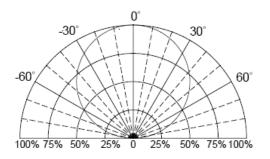
40

Ambient Temperature(°C)

60

80

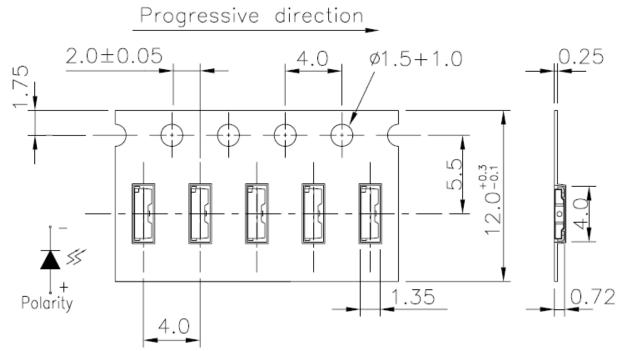
100





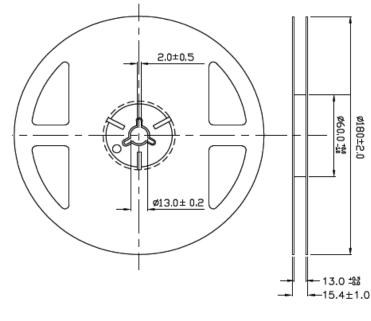
3.8 x 1.2 x 0.6 Green SMD, Tape and Reel

CARRIER TAPE DIMENSION



Note: The tolerances unless mentioned are ±0.1mm, Angle ±0.5; Unit=mm

REEL DIMENSIONS



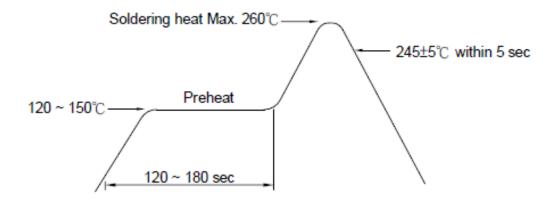
Notes:
1. 3000 pieces per reel
2. Tolerance unless mentioned is ±0.1mm; Unit=mm
Version 2.0 Date: 2-28-2013 Specifications are subject to change without notice.
American Opto Plus LED Corp. 1206 E. Lexington Ave., Pomona CA 91766 Tel: 909-465-0080 Fax: 909-465-0130 www.aopled.com



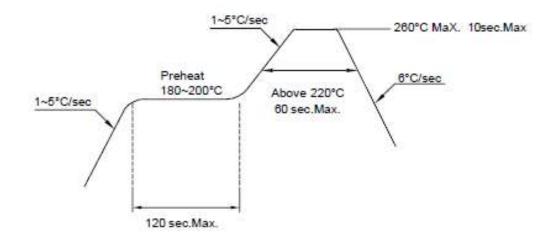
3.8 x 1.2 x 0.6 Green SMD, Tape and Reel

PRECAUTIONS FOR USE

- Hand solder Basic spec is ≤ 320°C 3 sec one time only.
- 2. Wave solder



3. PB-Free reflow solder



Notes:

- 1. Reflow soldering should not be done more than two times.
- 2. When soldering, do not put stress on the LEDs during heating.
- 3. After soldering, do not warp the circuit board.



3.8 x 1.2 x 0.6 Green SMD, Tape and Reel

PRECAUTIONS FOR USE:

Storage Time:

1. The operation of temperatures and RH are: 5°C~35°C, RH60%.

2. Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp proof box with descanting agent. Considering the tape life, we suggest our customers to use our products within a year (from production date).

3. If opened more than one week in an atmosphere 5°C~35°C, RH60%, they should be treated at 60°C±5°C for 15hrs.

Drive Method:

LED is a current operated device, and therefore, require some kind of current limiting incorporated into the driver circuit. This current limiting typically takes the form of a current limiting resistor placed in a series with the LED.

Consider worst case voltage variations that could occur across the current limiting resistor. The forward current should not be allowed to change by more than 40% of its desired value.



(A) Recommended circuit.

(B) The difference of brightness between LED could be found due to the VF-IF characteristics of LED.

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED.

ESD(Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or antielectrostatic glove is recommended when handling these LEDs. All devices and machinery must be properly grounded.



3.8 x 1.2 x 0.6 Green SMD, Tape and Reel

RELIABILITY TEST

1. Test items and results

Classification	Test Item	Test Condition	Sample Size
	Operating Life Test	1.Ta=Under Room Temperature As Per Data Sheet Maximum Rating. 2.If=20mA 3.t=1000 hrs	22
Endurance Test	High Temperature Storage Test	1.Ta=105℃±5℃ 2.t=500 hrs	22
	Low Temperature Storage Test	1.Ta=-40℃±5℃ 2.t=1000 hrs	22
	High Temperature High Humidity Storage Test	1.IR-Reflow In-Board, 2 Times 2.Ta=85℃±5℃ 3.RH=90%~95% 4.t=500hrs±2hrs	22
	Thermal Shock Test	1.IR-Reflow In-Board,2 times 2.Ta=105℃±5℃ & -40℃±5℃ (30min) (30min) 3.total 100 cycles	22
Environmental Test	Reflow Soldering Test	1.T.Sol=260℃±5℃ 2.Dwell Time= 10Max.	22
	Temperature Cycling	1.105℃ ~ 25℃ ~ -40℃ 30mins 15mins 30mins 2.100 Cyeles	22

2. Criteria for judging the damage

Item	Symbol	Test Conditions	Criteria for Judgement		
nem	Symbol		Min.	Max.	
Forward Voltage	Vf	lf=20mA	-	U.S.L x1.2	
Reverse Current	Ir	Vr=5V	-	U.S.L x2.0	
Luminous Intensity	Iv	lf=20mA	L.S.L x 0.5	-	

Note:

- 1. U.S.L.: Upper Standard Level
- 2. L.S.L.: Lower Standard Level